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T1010H

High temperature 10 A sensitive TRIACs

Features

- Medium current TRIAC
- Logic level sensitive TRIAC
- 150 °C max. T_i turn-off commutation
- Clip bounding
- RoHS (2002/95/EC) compliant packages

Applications

- The T1010H is designed for the control of AC actuators in appliances and industrial systems.
- The multi-port drive of the microcontroller can control the multiple loads of such appliances and systems through these sensitive gate TRIACs.

Description

Specifically designed to operate at 150 °C, the new 10 A T1010H TRIACs provide an enhanced performance in terms of power loss and thermal dissipation. This allows the optimization of the heatsink size, leading to space and cost effectiveness when compared to electromechanical solutions.

Based on ST logic level technology, they offer an I_{GT} lower than 10 mA and specified minimal commutation and high noise immunity levels valid up to the T_i max.

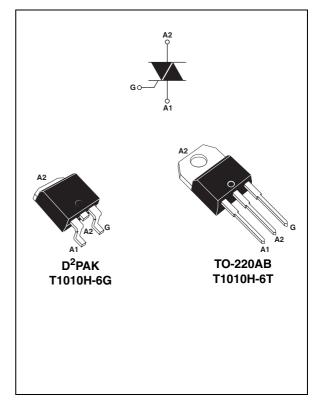


Table 1.	Device	summary
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Symbol	Value	Unit
I _{T(RMS)}	10	А
V _{DRM} /V _{RRM}	600	V
I _{GT MAX}	10	mA

1 Characteristics

Symbol	Param	Value	Unit		
I _{T(RMS)}	On-state rms current (full sine wave)	D ² PAK, TO-220AB	T _c = 135 °C	10	А
	Non repetitive surge peak on-state	F = 60 Hz	t = 16.7 ms 1		^
ITSM	current (full cycle, T_j initial = 25 °C)	F = 50 Hz	t = 20 ms	100	A
l ² t	I ² t Value for fusing	t _p = 10 ms		66	A ² s
dl/dt	Critical rate of rise of on-state current $I_G = 2 \ x \ I_{GT}$, $t_r \leq 100 \ ns$	F = 120 Hz	T _j = 150 °C	50	A/µs
V _{DSM} /V _{RSM}	Non repetitive surge peak off-state voltage $t_p = 10 \text{ ms}$		T _j = 25 °C	V _{DRM} /V _{RRM} + 100	V
I _{GM}	Peak gate current $t_p = 20 \ \mu s$ $T_j = 150 \ ^{\circ}C$		4	А	
P _{G(AV)}	Average gate power dissipation	1	W		
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 150	°C

Table 2. Absolute maximum ratings

Table 3.Electrical characteristics (T_i = 25 °C, unless otherwise specified)

Symbol	Test conditions	Quadrant	Min.	Max.	Unit
I _{GT}	V 10 V B 22 0	- -	1	10	mA
V _{GT}	V_{GT} $V_{\text{D}} = 12 \text{ V}$ $\text{R}_{\text{L}} = 33 \Omega$	1 - 11 - 111		1.0	V
V _{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	1 - 11 - 111	0.15		V
Ι _Η ⁽¹⁾	I _T = 100 mA			25	mA
	1 101	1 - 111		30	
۱ _L	$I_{G} = 1.2 I_{GT}$	II		35	— mA
dV/dt ⁽¹⁾	$V_D = 67\% V_{DRM}$, gate open, $T_j = 150 \text{ °C}$	L.	75		V/µs
(d)/dt) a (1)	$(dI/dt)c^{(1)} \frac{\text{Logic level, 0.1 V/}\mu\text{s, T}_{j} = 150 ^{\circ}\text{C}}{\text{Logic level, 15 V/}\mu\text{s, T}_{j} = 150 ^{\circ}\text{C}}$		14.4		A/ms
(ui/ut)C (/			3.8		Avins

1. For both polarities of A2 referenced to A1.



Symbol	Test cond	Value	Unit		
$V_{T}^{(1)}$	I _{TM} = 14.1 A, t _p = 380 μs	T _j = 25 °C	MAX.	1.5	V
V _{t0} ⁽¹⁾	Threshold voltage	T _j = 150 °C	MAX.	0.80	V
R _d ⁽¹⁾	Dynamic resistance	T _j = 150 °C	MAX.	41.0	mΩ
	<u> </u>	T _j = 25 °C	MAX.	5	μA
I _{DRM}	V _{DRM} = V _{RRM}	T _j = 150 °C	MAX.	3.6	
I _{RRM}	$V_D/V_R = 400 V$ (at peak mains voltage)	T _j = 150 °C	MAX.	3.0	mA
	$V_D/V_R = 200 V$ (at peak mains voltage)	T _j = 150 °C	MAX.	2.5	

Table 4.Static characteristics

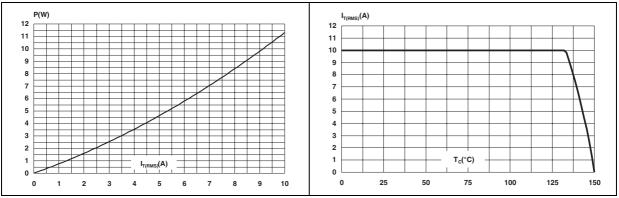
1. for both polarities of A2 referenced to A1.

Table 5.Thermal resistance

Symbol		Value	Unit		
R _{th(j-c)}	Junction to case (AC)		D ² PAK / TO-220AB	1.50	
D	Junction to ambient	$S = 1 \text{ cm}^2$	D ² PAK	45	°C/W
R _{th(j-a)}	Junction to ambient		TO-220AB	60	

Figure 1. Maximum power dissipation versus Figure 2. on-state rms current (full cycle)

On-state rms current versus case temperature (full cycle)





2.5

2.0

1.5

1.0

0.5

0.0

-50

Figure 3. On-state rms current versus ambient temperature (free air convection, (full cycle)

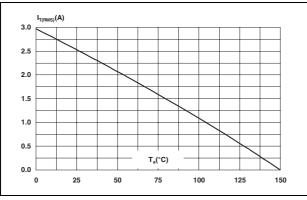
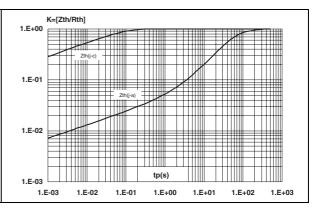


Figure 5. Relative variation of gate trigger Figure 6. current and voltage versus junction temperature (typical values)



 Relative variation of holding and latching current versus junction temperature (typical values)

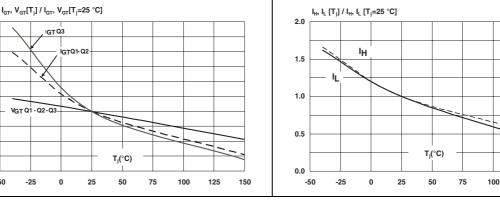
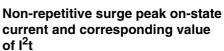


Figure 7. Surge peak on-state current versus Figure 8. number of cycles



125

150

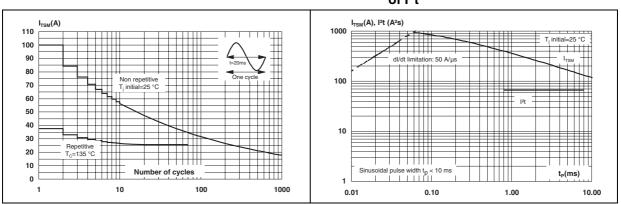
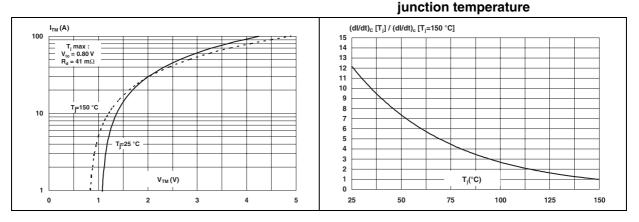
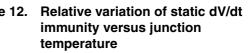


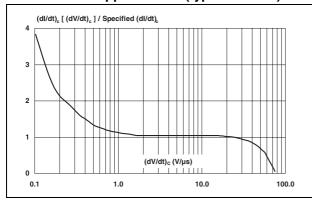


Figure 9. On-state characteristics (maximum Figure 10. Relative variation of critical rate of decrease of main current versus values)



Relative variation of critical rate of Figure 12. Figure 11. decrease of main current versus reapplied dV/dt (typical values)





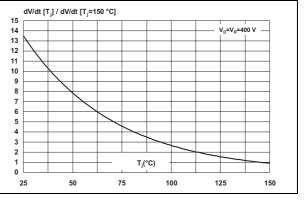
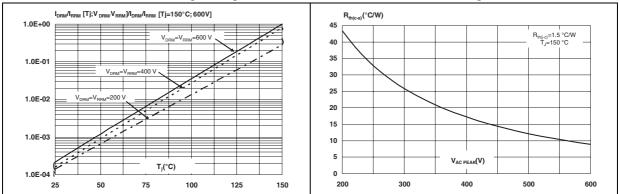
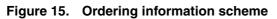


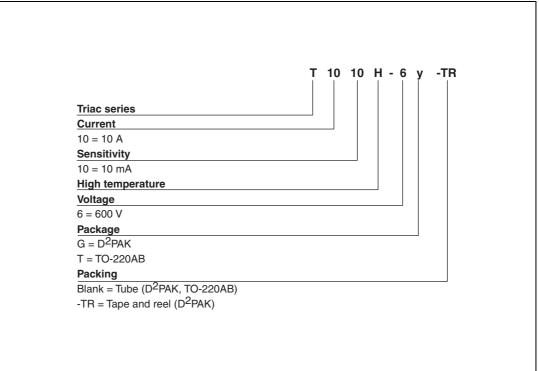
Figure 13. Variation of leakage current versus Figure 14. Acceptable case to ambient thermal junction temperature for different values of blocking voltage

resistance versus repetitive peak off-state voltage



2 Ordering information scheme







57

3 Package information

- Epoxy meets UL94, V0
- Recommended torque 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 6.D²PAK dimensions

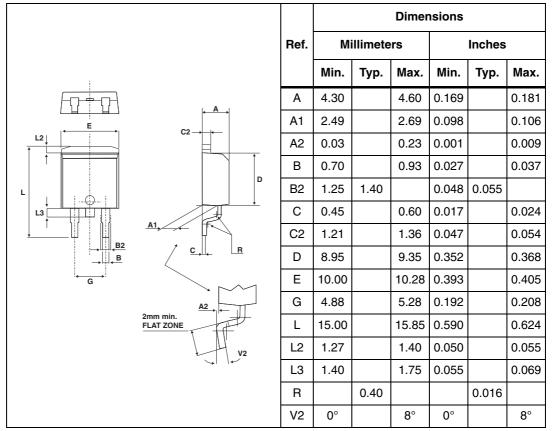
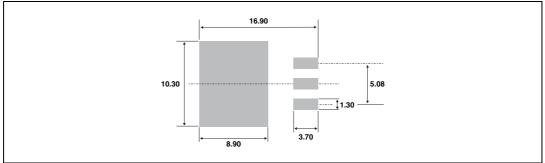


Figure 16. Footprint (dimensions in mm)





					Dimer	nsions		
		Ref.	Mi	illimete	ers		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
		a1		3.75			0.147	
B	C	a2	13.00		14.00	0.511		0.551
ØI	<u>b2</u>	В	10.00		10.40	0.393		0.409
	G2 M M C1	b1	0.61		0.88	0.024		0.034
		b2	1.23		1.32	0.048		0.051
14		С	4.40		4.60	0.173		0.181
		c1	0.49		0.70	0.019		0.027
		c2	2.40		2.72	0.094		0.107
		е	2.40		2.70	0.094		0.106
↓ ↓ ↓ ↓ ↓ ↓ ↓ b1		F	6.20		6.60	0.244		0.259
e	→!!	ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		13	1.14		1.70	0.044		0.066
		М		2.60			0.102	

Table 7. TO-220AB dimensions



4 Ordering information

Table 8. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
T1010H-6G	T1010H 6G	D ² PAK	1.5 g	50	Tube
T1010H-6G-TR	T1010H 6G	D ² PAK	1.5 g	1000	Tape and reel
T1010H-6T	T1010H 6T	TO-220AB	2.3 g	50	Tube

5 Revision history

Table 9.Document revision history

Date	Revision	Changes
15-May-2009	1	First issue.



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